



Materials Declaration Form


IPC Form Type *	1752 Distribute	Version	2
Sectionals *	Material Info Manufacturing Info	Subsectionals *	A-D

* : Required Field

Supplier Information			
Company Name *	STMicroelectronics	Response Date *	2018-09-03
Company Unique ID	NL 008751171B01		
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact Phone *	Refer to Supplier Comment section	Contact Email *	Refer to Supplier Comment section
Authorized Representative *	MDG MD CHAMPION	Representative Title	MDG MD CHAMPION
Representative Phone *	Refer to Supplier Comment section	Representative Email *	Refer to Supplier Comment section
Supplier Comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty Statement	
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Legal Statement	
Supplier Acceptance *	true
Legal Declaration *	Standard
Legal Statement	<p>Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.</p>

Product				
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date
STM32L431KCU6	76MG*435XXXZ	A	998Z	2018-09-03
	Amount	UoM	Unit type	ST ECOPACK Grade
	49.751	mg	Each	ECOPACK® 2
	Comment	ECOPACK® 2 is STMicroelectronics trade name for ROHS compliant device without Brominated and Chlorinated compound (900ppm) and without Antimony oxide flame retardant (in each organic material)		

Manufacturing information				
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles		 life.augmented
3	260	3		
bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	
able; if coating is used or other bulk	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy		

Package Designator	Size	Nbr of instances	Shape	
QFN	5x5x0.55	32	No lead	
Comment	Package : A0B8 UFQFPN 5X5X0.55 32L 0.5 MM PITCH 8202208			

QueryList : RoHS Directive 2011/65/EU-July 2011 – Annex II amended by Directive 2015/863-April 2015	
Query	Response
1 - Product(s) meets EU RoHS requirement without any exemptions	TRUE
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)	FALSE
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	FALSE
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions	FALSE
Exemption Id.	Description

QueryList : REACH-12th January 2017				
Query				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				TRUE
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product

Material Composition Declaration :						Mfr Item Name	76MG*435XXXZ				5999999.0	1000005.2
note : Substance present with less 0.001mg will not be declared in this document												
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die or dies	M-011 Other inorganic materials	3.511	mg	supplier	die	Silicon (Si)	7440-21-3		3.171	mg	903161	63738
				supplier	metallization	Aluminium (Al)	7429-90-5		0.016	mg	4557	322
				supplier	metallization	Copper (Cu)	7440-50-8		0.144	mg	41014	2894
				supplier	metallization	Tantalum (Ta)	7440-25-7		0.047	mg	13386	945
				supplier	metallization	Titanium (Ti)	7440-32-6		0.002	mg	570	40
				supplier	metallization	Tungsten (W)	7440-33-7		0.001	mg	285	20
				supplier	Passivation	Silicon Nitride	12033-89-5		0.037	mg	10538	744
				supplier	Passivation	Silicon Oxide	7631-86-9		0.093	mg	26488	1869
				Supplier	Metals	Nickel	7440-02-0		0.793	mg	29365	15937
Leadframe_C7+Ag_HDS	Metals	27.000	mg	Supplier	Glass	Silicon	7440-21-3		0.176	mg	6500	3528
				Supplier	Metals	Magnesium	7439-95-4		0.042	mg	1565	849
				Supplier	Metals	Silver	7440-22-4		1.701	mg	63000	34191
				Supplier	Metals	Copper	7440-50-8		24.288	mg	899570	488203
				Supplier	Metals	Silver	7440-22-4		0.751	mg	787329	15102
Die Attach Epoxy_ABLEBOND 8290_H	M-011 Other inorganic materials	0.954	mg	Supplier	Organic Compounds	Epoxy Resin 1	Proprietary		0.024	mg	24750	475
				Supplier	Organic Compounds	Epoxy Resin 2	Proprietary		0.024	mg	24750	475
				Supplier	Organic Compounds	Gamma Butyrolactone	96-48-0		0.052	mg	54129	1038
				Supplier	Organic Compounds	Epoxy Resin 3	Proprietary		0.024	mg	24750	475
				Supplier	Organic Compounds	Amine	Proprietary		0.024	mg	24750	475
				Supplier	Metallic compounds	Copper Oxide	1317-38-0		0.052	mg	54129	1038
				Supplier	Organic Compounds	1,4-Bis(2,3-epoxypropoxy) butane	2425-79-8		0.005	mg	5413	104
				Supplier	Organic Compounds	Epoxy Resin A	Proprietary		0.324	mg	19837	6522
				Supplier	Organic Compounds	Epoxy Resin B	Proprietary		0.324	mg	19837	6522
EMC_G770_Sumitomo	M-011 Other inorganic materials	16.356	mg	Supplier	Organic Compounds	Phenol Resin A	Proprietary		0.324	mg	19837	6522
				Supplier	Organic Compounds	Phenol Resin B	Proprietary		0.324	mg	19837	6522
				Supplier	Organic Compounds	Phenol Resin B	Proprietary		0.324	mg	19837	6522
				Supplier	Glass	Silica (Amorphous) A	60676-86-0		11.980	mg	732452	240805
				Supplier	Glass	Silica (Amorphous) B	7631-86-9		2.662	mg	162767	53512
				Supplier	Alkali	Metal Hydroxide	Proprietary		0.324	mg	19837	6522
				Supplier	Additives	Carbon Black	1333-86-4		0.092	mg	5595	1839
				Supplier	Metals	Gold	7440-57-5		0.270	mg	1000000	5424
				Supplier	Metals	Tin	7440-31-5		1.659	mg	1000000	33356
BondingWire_Au_MKE	Bonding Wire	0.270	mg	Supplier	Metals	Gold	7440-57-5		0.270	mg	1000000	5424
Anode Ball_Tin_Asahi	Metals	1.659	mg	Supplier	Metals	Tin	7440-31-5		1.659	mg	1000000	33356